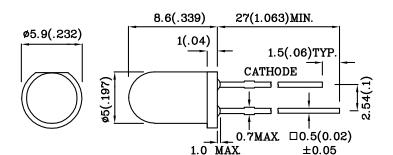


Features

- LOW POWER CONSUMPTION.
- POPULAR T-1 3/4 DIAMETER PACKAGE.
- GENERAL PURPOSE LEADS.
- RELIABLE AND RUGGED.
- LONG LIFE SOLID STATE RELIABILITY.
- AVAILABLE ON TAPE AND REEL.
- 5V INTERNAL RESISTOR.
- RoHS COMPLIANT.



Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.

Absolute maximum rating (TA=25°C)	UY (GaAsP/ GaP)	Unit		
Reverse voltage	VR	5	V	
Forward voltage	VF	6	V	
Power dissipation	Рт	85	mW	
Operating temperature	ТА	$-40 \sim +70$	°C	
Storage temperature	Tstg	$-40 \sim +85$		
Lead solder temperature [2mm below package base]	260°C For 3 Seconds			
Lead solder temperature [5mm below package base]	260°C For 5 Seconds			

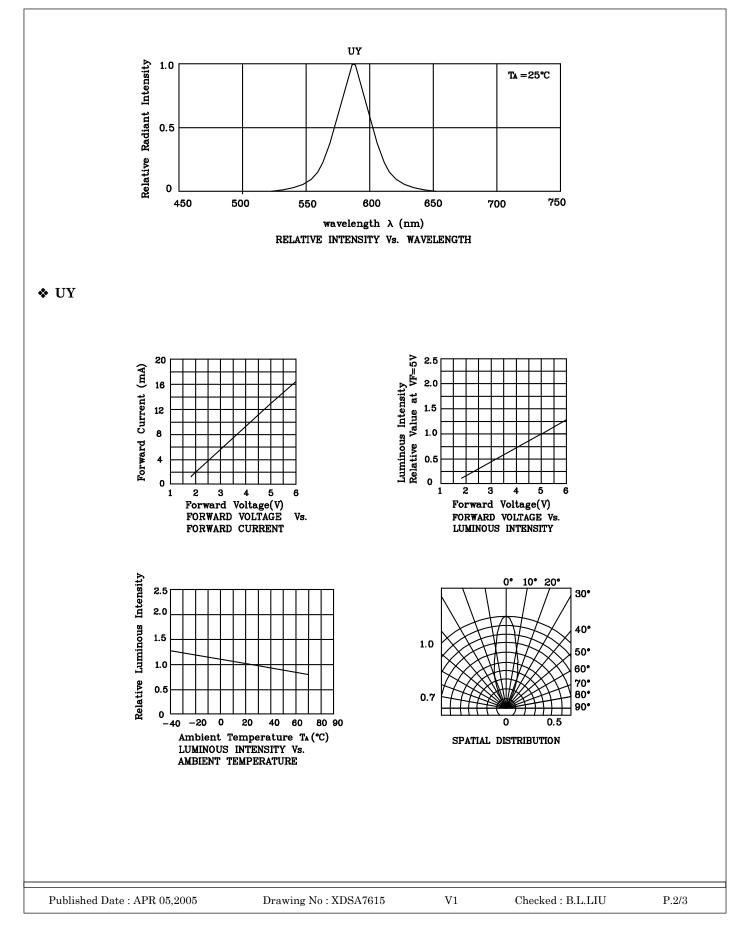
Operating Characteristic (TA=25°C)	UY (GaAsP/ GaP)	Unit	
Forward current (typ.) (VF=5V)	IF	13	mA
Forward current (max.) (VF=5V)	IF	17.5	mA
Reverse current (VR=5V)	IR	10	uA
Wavelength at peak emission (VF=5V)	λ peak	590	nm
Wavelength of Dominant emission (VF=5V)	λD	588	nm
Spectral Line half-width (VF=5V)	Δλ	35	nm

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (V=5V) mcd		Wavelength nm λ P	Viewing Angle 2θ1/2
				min.	typ.		
XLUY12D5V	Yellow	GaAsP/GaP	Yellow Diffused	5	19	590	30°
Published Date :	APR 05,2005	Drawing	No : XDSA7615	V1	Check	ed : B.L.LIU	P.1/3

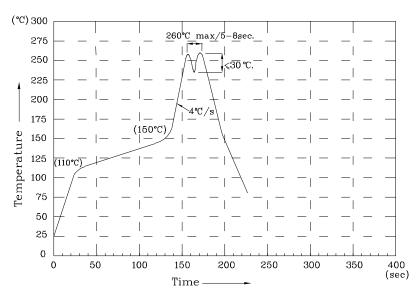


Part Number: XLUY12D5V

T-1 3/4 (5mm) SOLID STATE LAMP







Wave Soldering Profile For Lead-free Through-hole LED.

NOTES:

 Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
Do not apply stress on epoxy resins when temperature is over 85 degree°C.
The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
No more than once.

Remarks:

If special sorting is required (e.g. binning based on $\,$ luminous intensity, or wavelength), the typical

accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%

Note: Accuracy may depend on the sorting parameters.